



ISO 1043

Sim. to ISO 62

Sim. to ISO 62

ISO 1183

HOSTAFORM® MR130ACS

HOSTAFORM®

Product information
Resin Identification

Hostaform® acetal copolymer grade MR130ACS is formulated with enhanced acid stabilization. Hostaform® MR130ACS demonstrates improved performance over standard acetals after intermittent exposure to acidic cleaners.

POM

0.3 %

1.7 %

1410 kg/m³

| Part Marking Code | >POM< | | ISO 11469 |
|--|---------------------|------------------------|----------------|
| Rheological properties | | | |
| Melt volume-flow rate | 12 | cm ³ /10min | ISO 1133 |
| Temperature | 190 | °C | |
| Load | 2.16 | kg | |
| Typical mechanical properties | | | |
| Tensile modulus | 2900 | MPa | ISO 527-1/-2 |
| Tensile stress at yield, 50mm/min | 62 | MPa | ISO 527-1/-2 |
| Tensile strain at yield, 50mm/min | 11 | % | ISO 527-1/-2 |
| Nominal strain at break | 30 | % | ISO 527-1/-2 |
| Charpy impact strength, 23°C | | kJ/m² | ISO 179/1eU |
| Charpy impact strength, -30°C | | kJ/m² | ISO 179/1eU |
| Charpy notched impact strength, 23°C | | kJ/m² | ISO 179/1eA |
| Charpy notched impact strength, -30°C | | kJ/m² | ISO 179/1eA |
| Ball indentation hardness, H 358/30 | | MPa | ISO 2039-1 |
| Poisson's ratio | 0.37 ^[C] | | |
| [C]: Calculated | | | |
| Thermal properties | | | |
| Melting temperature, 10°C/min | 170 | °C | ISO 11357-1/-3 |
| Temperature of deflection under load, 1.8 MPa | 100 | °C | ISO 75-1/-2 |
| Coefficient of linear thermal expansion (CLTE), parallel | 94 | E-6/K | ISO 11359-1/-2 |
| Coefficient of linear thermal expansion (CLTE), | 100 | E-6/K | ISO 11359-1/-2 |
| normal | | | |
| Physical/Other properties | | | |

Injection

Density

Humidity absorption, 2mm

Water absorption, 2mm

| Drying Recommended | no |
|---------------------------------|----------|
| Drying Temperature | 100 °C |
| Drying Time, Dehumidified Dryer | 3-4 h |
| Processing Moisture Content | ≤0.2 % |
| Melt Temperature Optimum | 200 °C |
| Min. melt temperature | 190 °C |
| Max. melt temperature | 210 °C |
| Screw tangential speed | ≤0.3 m/s |
| Mold Temperature Optimum | 100 °C |
| | |

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Revised: 2024-07-17 Source: Celanese Materials Database





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Min. mould temperature80 °CMax. mould temperature120 °CHold pressure range60 - 120 MPaBack pressure4 MPa

Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent
Special characteristics Chemical resistant

Additional information

Processing Notes Pre-Drying

Pre-drying is recommended.

Storage

Standard drying conditions are 82 deg C (180 deg F) for 3 hours.

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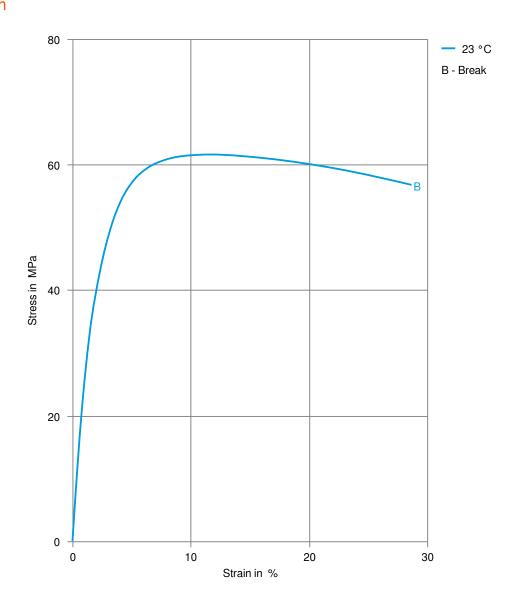




HOSTAFORM® MR130ACS

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Stress-strain



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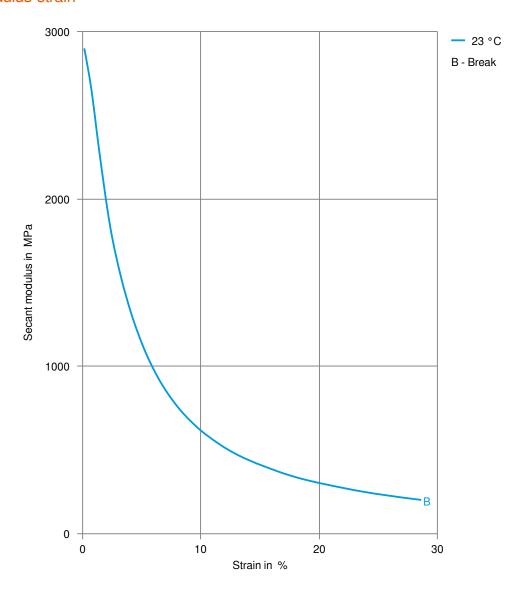




HOSTAFORM® MR130ACS

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Secant modulus-strain



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